Partner Quote Sheet

Qualcomm Dragonfly

Advantest

“As a leader in data center test solutions and a collaborator with Qualcomm Technologies in production test, we are excited to support Qualcomm Technologies’ new set of amazing products and solutions for data centers,” said Sanjeev Mohan, Senior Executive Officer and Customer Relations Officer, Advantest. “Our longstanding relationship has been built on a shared commitment to innovation, quality, and performance, and we are grateful to contribute to this growing ecosystem with superior test solutions.”

Arista

“Arista is pleased to support Qualcomm Technologies’ data center vision and its Qualcomm Dragonfly roadmap, which brings together compute, AI acceleration, memory innovation, and connectivity to help customers build scalable, open, and power-efficient AI systems,” said Mark Foss, Senior Vice President of Operations and Marketing, Arista Networks.

Astera

"AI infrastructure is entering a new phase where heterogeneous computing and purpose-built connectivity is mandatory. The challenge is no longer raw compute alone, but how efficiently CPUs orchestrate data movement across accelerators, memory, and connectivity as one system for increasingly agentic AI workloads. Astera's Intelligent Connectivity Platform and Qualcomm Technologies’ push into the data center reflects that shift and adds to the range of architectures customers can consider as they build and scale AI on their own terms,” said Jitendra Mohan, CEO & Cofounder, Astera Labs.

Cirrascale

"The AI infrastructure market is strongest when customers have real choice across silicon, systems, and cloud delivery models. Qualcomm Technologies’ move into the data center is a meaningful addition to that ecosystem, and their focus on performance-per-watt is well aligned with where AI compute is heading. Cirrascale is proud to support Qualcomm Technologies' data center vision and help bring their technology to AI innovators through

the Cirrascale AI Innovation Cloud," said Dave Driggers, CEO and Co-founder, Cirrascale Cloud Services.

Compal

“The future of data center innovation is built on close ecosystem collaboration. Qualcomm Technologies’ expansion into the data center market brings valuable momentum, and Compal is pleased to work alongside Qualcomm Technologies to translate silicon innovation into optimized, production-ready systems. Our collaboration reflects a shared commitment to delivering scalable, energy-efficient platforms, and we look forward to deepening our collaboration to accelerate next-generation data center innovation,” said Tony Bonadero, CEO, Compal.

Confidential Core AI

"Qualcomm Technologies’ data center roadmap has the potential to redefine enterprise AI infrastructure for the next decade," said Taher Behbehani, CEO & Co-founder, Confidential Core AI. "We are proud to have collaborated with Qualcomm Technologies to build confidential inference into their software stack as a foundational capability. This architecture drives secure, safe and efficient AI outcomes for sovereign deployments, and secure enterprise agentic AI operations."

Core42

“As global demand for AI accelerates, data center infrastructure is emerging as a foundational driver of performance, efficiency, and innovation. Qualcomm Technologies’ evolving portfolio aligns closely with this transformation, emphasizing the delivery of intelligence at the point of need. At Core42, we value our strategic collaboration with Qualcomm Technologies as we jointly advance flexible, scalable AI infrastructure and enable the next generation of digital services,” said Talal M. Al Kaissi, Chief Executive Officer (Interim), Core42.

Fibercop

"Enterprises are looking for purpose-built data center platforms that deliver predictable performance, efficiency, proximity and long-term roadmap confidence. FiberCop, through

its continued fiber network deployment and the transformation of its central office infrastructure towards Proximity AI, is ready to support this strategic path. Qualcomm Technologies' move into the data center reflects a thoughtful approach to these requirements, and we believe their technology will expand options for customers building modern, AI-ready data center environments," said Stefano Paggi, CTOO, Fibercop.

Foxconn

"Qualcomm Technologies' entrance into the data center market represents a meaningful step for the industry. Their focus on high performance, power efficient compute aligns directly with the needs of modern cloud infrastructure, where performance, scalability, and sustainability must advance together. Qualcomm Technologies is well positioned to contribute to the next generation of data center architecture. Enterprises are looking for purpose-built data center platforms that deliver predictable performance, efficiency, and long-term roadmap confidence. Qualcomm Technologies' move into the data center will expand options for customers building modern, AI ready data center environments," said Young Liu, Chairman and President, Foxconn.

GIGABYTE Technology

"Strong data center platforms are built through ecosystem collaboration, from silicon to software," said Etay Lee, CEO, GIGABYTE Technology. "Through close collaboration with Qualcomm Technologies, we are accelerating the deployment of rack-scale AI infrastructure to support the next generation of AI factories. By integrating advanced compute and operational management platforms, we are enabling scalable, AI-ready data center environments optimized for long-term growth."

HUMAIN

"At HUMAIN, we believe the future of AI will be built through open collaboration, deep technology engagements, and a globally connected infrastructure ecosystem capable of enabling innovation at unprecedented scale. Our collaboration with Qualcomm across multiple layers of the AI stack reflects that ambition. Qualcomm's data center portfolio announcement marks an important milestone for the industry and reinforces the growing importance of high-performance, energy-efficient, intelligent infrastructure in powering the

next era of AI. It will also play a key role in supporting HUMAIN's ambitious vision to develop massive gigawatt-scale data centers in Saudi Arabia with global reach. Companies like Qualcomm that can combine innovation, scalability, efficiency, and ecosystem leadership will define the next chapter of AI infrastructure," said Tareq Amin, CEO, HUMAIN.

IONOS

"Qualcomm Technologies' entry into the data center market marks a significant milestone for the industry. Its focus on high-performance, power-efficient computing closely aligns with the evolving demands of modern cloud infrastructure, where performance, scalability, and sustainability must progress in tandem. Qualcomm Technologies is emerging as an important new force shaping the next generation of data center architecture," said Andreas Nauerz, Chief Product Officer, IONOS.

Master Works

"As AI adoption accelerates across the Kingdom of Saudi Arabia, next-generation digital infrastructure is becoming a strategic enabler of national performance, resilience, and innovation at scale. Qualcomm Technologies' forward-looking technology roadmap closely aligns with this shift, enabling seamless, hybrid AI processing from centralized data centers to the intelligent edge where real-time insights drive the greatest impact. At Master Works, our collaboration with Qualcomm Technologies and HUMAIN underscores a shared commitment to advancing Saudi Arabia's digital transformation agenda. Together, we are delivering secure, scalable, and sovereign AI solutions particularly in computer vision and advanced analytics that empower government entities to optimize operations, elevate service delivery, and meaningfully enhance the daily lives of citizens, residents and visitors across the Kingdom," said Hani Al Lehaibi, Chairman, Master Works.

Microchip Technology

"Qualcomm Technologies' expansion into the data center market reflects a strong focus on the high-performance, power-efficient compute needed for modern AI infrastructure," said Brian McCarson, Corporate Vice President and GM, Microchip Technology's Data Center Solutions Business Unit. "As part of Qualcomm Technologies' growing data center ecosystem, Microchip's 3 nm Switchtec™ PCIe® Gen 6 switches enable the high bandwidth,

low latency and scalability required to efficiently move data across next-generation systems."

Micron Technology

"The next generation of AI data centers will increasingly depend on tightly integrated compute, memory, storage and connectivity to deliver the performance, power efficiency and scale required for agentic AI," said Sanjay Mehrotra, Chairman, President and CEO, Micron Technology. "Micron's leadership in memory and data center SSDs, combined with Qualcomm Technologies' long-standing leadership in low-power computing, silicon innovation and its expansion in the datacenter, provides a strong foundation for collaboration to advance a scalable AI infrastructure ecosystem."

Nanya Technology

"This collaboration marks a significant milestone in our strategic collaboration with Qualcomm Technologies. Nanya Technology is proud to provide innovative and reliable technologies that support the growing demands of AI and next-generation data centers. We look forward to contributing to Qualcomm's long-term success by delivering solutions that enable performance, scalability, and future growth."

NEC

"We believe that the Qualcomm Dragonfly solutions will play a vital role in enhancing the social infrastructure needed to efficiently support AI workloads, including inference, as agent-based AI becomes increasingly integrated into society. NEC is dedicated to enabling an AI-native society where AI plays a central role. To realize this, we are pursuing Trusted Connectivity — a comprehensive approach that integrates and reliably connects devices, edge infrastructure, networks, and data centers. As a valued collaborator with Qualcomm Technologies, NEC is committed to continuing our collaboration beyond Dragonfly, and working together on ongoing initiatives to bring this vision to life," said Mr. Takashi Sato, Corporate Senior Vice President, Head of Network Solutions Business Division, NEC Corporation.

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Qualcomm Dragonfly

NeuReality

“The future of AI infrastructure will not be built around a single processor. It will be built around highly efficient, heterogenous and disaggregated AI factories where specialized compute resources work together to maximize token throughput, efficiency, interactivity, and economics. Qualcomm Technologies' innovation in power-efficient compute with their advanced memory architecture, makes it an important leader in this market transition. Together with our disaggregation networking technology, we are enabling heterogeneous AI clusters that match the right processor to the right workload, creating the foundation of the next generation of scalable, cost-efficient AI inference,” said Moshe Tanach, CEO, NeuReality.

Pegatron Corporation

“We are delighted to see how closely Pegatron’s vision for next-generation computing infrastructure aligns with Qualcomm Technologies' impressive data center portfolio. This collaboration is truly significant. It represents an important step forward in meeting the industry's growing demand for high-performance, energy-efficient architectures, especially as modern workloads continue to scale at an unprecedented rate. We deeply value this collaboration and are excited about the opportunities it brings as we work together to push the boundaries of what’s possible in cloud computing,” said Gary Cheng, President and CEO, Pegatron.

Samsung SDS

"Samsung SDS and Qualcomm Technologies continue to engage in discussions on various promising business and technology opportunities, while exploring potential areas of collaboration," said Junehee Lee, CEO, Samsung SDS.

Saptiva AI

“Saptiva AI is building the sovereign AI control plane for regulated enterprise and government in Latin America. Qualcomm Technologies’ data center platform enables us with hardware that takes power efficiency and edge

deployment seriously, exactly the silicon profile we need to bring FrIdA across the region," said Angel Cisneros, Founder & CEO, Saptiva AI.

SK hynix America

"As AI workloads become more complex and memory-intensive, the industry needs new approaches that bring compute and memory closer together while improving performance per watt," said Sungsoo Ryu, CEO, SK hynix America. "We support Qualcomm Technologies' expanded data center strategy and its focus on enabling efficient, scalable infrastructure for the agentic AI era."

Supermicro

"We are proud to support Qualcomm Technologies, and their vision for next-generation AI data centers, as it expands the Dragonfly portfolio," said Charles Liang, president and CEO, Supermicro. "Qualcomm Dragonfly platforms and Supermicro's Data Center Building Block Solutions® (DCBBS) enables efficient, scalable AI infrastructure that accelerates agentic AI data center deployments worldwide."

Teradyne

"For decades, Teradyne and Qualcomm Technologies have grown together through true strategic engagement. Our collaboration is grounded in a shared commitment to innovation and a determination to get it right. As Qualcomm Technologies expands into their next phase of growth, centered on the rapidly expanding AI market, we are proud to stand alongside them," said Shannon Poulin, President, Semiconductor Test Group, Teradyne.

TeraHop

"Our hyperscaler customers expect optical module solutions with outstanding performance with robust critical component supplies. We are pleased to collaborate with Qualcomm Technologies on expanding optical DSP capabilities and are looking forward to collaborating with Qualcomm Technologies for photonic solutions," said Rang-Chen Yu, VP of Marketing, TeraHop.

Partner Quote Sheet

Qualcomm Dragonfly

UMC

“As AI infrastructure evolves, advanced packaging and manufacturing collaboration are becoming increasingly important to delivering the performance, power efficiency, and scale required for next-generation data centers,” said Jason Wang, Chief Executive Officer, UMC. “UMC is pleased to collaborate with Qualcomm Technologies as it advances its data center roadmap, bringing together our deep semiconductor manufacturing expertise and advanced packaging solutions with Qualcomm Technologies' system-level innovation to help enable more efficient, high-performance compute for the agentic AI era.”

VAST Data

"As inference becomes reasoning-intensive and continuously running, computing efficiency in today's power-constrained environment becomes a first-order concern," said Jeff Denworth, Co-Founder, VAST Data. "Qualcomm Technologies’ approach recognizes that performance-efficient inferencing is a full-stack problem, and we’re excited to collaborate with them to bring VAST’s intelligent data foundation to help customers preserve context, serve data efficiently, and support next-generation AI services.”

Viettel IDC

“AI is transforming industries, and its success depends on scalable, high-performance infrastructure. Qualcomm Technologies’ technology provides enterprises with better choice and more efficient access to AI capabilities. Together, Viettel IDC and Qualcomm Technologies’ are building a high-performance AI platform designed for energy efficiency and cost-effective scale, enabling AI adoption in Vietnam and beyond," said Le Ba Tan, Chief Executive Officer, Viettel IDC.

VNPT Group

“VNPT values its strategic collaboration with Qualcomm Technologies across data center, Edge AI, and on-device AI technologies, and looks forward to expanding this collaboration to accelerate the development of advanced cloud and AI infrastructure in Vietnam. Being Vietnam’s top data center and digital service provider, we aim to enable a more scalable, intelligent, and sustainable digital ecosystem,” said Huynh Quang Liem, Chief Executive

Officer, VNPT Group. “Qualcomm Technologies’ strategic entry into the data center domain represents a pivotal milestone for the industry. Its focus on high-performance, energy-efficient computing aligns strongly with the evolving needs of modern cloud and AI infrastructure, where scalability and sustainability must advance together. We see Qualcomm Technologies emerging as an important force shaping next-generation data center architectures and driving innovation across the digital ecosystem.”